

## APT10050JVR

**1000V 19A 0.500** $\Omega$ 

# POWER MOS V<sup>®</sup>

Power MOS  $V^{\otimes}$  is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS  $V^{\otimes}$  also achieves faster switching speeds through optimized gate layout.

ISOTOP®

Faster Switching

100% Avalanche Tested

Lower Leakage

Popular SOT-227 Package



#### **MAXIMUM RATINGS**

All Ratings:  $T_C = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	APT10050JVR	UNIT		
$V_{\rm DSS}$	Drain-Source Voltage	1000	Volts		
I <sub>D</sub>	Continuous Drain Current @ T <sub>C</sub> = 25°C	19	Amns		
I <sub>DM</sub>	Pulsed Drain Current ①	76	Amps		
V <sub>GS</sub>	Gate-Source Voltage Continuous	±30	Volts		
V <sub>GSM</sub>	Gate-Source Voltage Transient	±40			
D	Total Power Dissipation @ T <sub>C</sub> = 25°C	450	Watts		
$P_{D}$	Linear Derating Factor	3.6	W/°C		
$T_J$ , $T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	- °C		
T <sub>L</sub>	Lead Temperature: 0.063" from Case for 10 Sec.	300	] [		
I <sub>AR</sub>	Avalanche Current (Repetitive and Non-Repetitive)	19	Amps		
E <sub>AR</sub>	Repetitive Avalanche Energy ①	50			
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>(4)</sup>	2500	- mJ		

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage ( $V_{GS} = 0V, I_D = 250\mu A$ )	1000			Volts
I <sub>D(on)</sub>	On State Drain Current ② $(V_{DS} > I_{D(on)} \times R_{DS(on)} Max, V_{GS} = 10V)$	19			Amps
R <sub>DS(on)</sub>	Drain-Source On-State Resistance ② (V <sub>GS</sub> = 10V, 0.5 I <sub>D[Cont.]</sub> )			0.500	Ohms
I <sub>DSS</sub>	Zero Gate Voltage Drain Current $(V_{DS} = V_{DSS}, V_{GS} = 0V)$			25	μΑ
	Zero Gate Voltage Drain Current ( $V_{DS} = 0.8 V_{DSS}$ , $V_{GS} = 0V$ , $T_{C} = 125$ °C)			250	
I <sub>GSS</sub>	Gate-Source Leakage Current $(V_{GS} = \pm 30V, V_{DS} = 0V)$			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 2.5 \text{mA})$	2		4	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

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Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V		6600	7900	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25V		595	830	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		290	430	
$Q_g$	Total Gate Charge <sup>③</sup>	V <sub>GS</sub> = 10V		335	500	
Q <sub>gs</sub>	Gate-Source Charge	$V_{DD} = 0.5 V_{DSS}$		29	45	nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	$I_{D} = I_{D[Cont.]} @ 25^{\circ}C$		165	250	
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> = 15V		16	32	
t <sub>r</sub>	Rise Time	$V_{DD} = 0.5 V_{DSS}$		13	26	no
t <sub>d(off)</sub>	Turn-off Delay Time	$I_{D} = I_{D[Cont.]} @ 25^{\circ}C$		59	90	ns
t <sub>f</sub>	Fall Time	$R_{G} = 0.6\Omega$		8	16	

#### SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

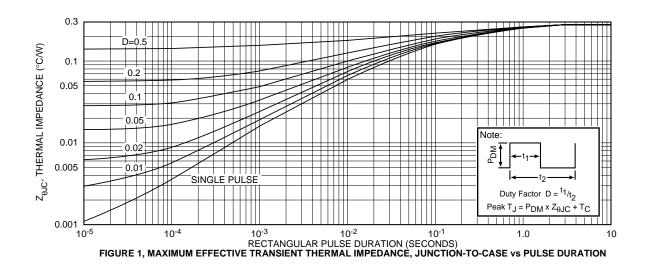
Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I <sub>s</sub>	Continuous Source Current (Body Diode)			19	Amna
I <sub>SM</sub>	Pulsed Source Current (1) (Body Diode)			76	Amps
$V_{SD}$	Diode Forward Voltage ② $(V_{GS} = 0V, I_{S} = -I_{D[Cont.]})$			1.3	Volts
t rr	Reverse Recovery Time $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$		960		ns
Q rr	Reverse Recovery Charge $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$		22		μС

### THERMAL/PACKAGE CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT	
$R_{\theta JC}$	Junction to Case			0.28	°C/M	
$R_{\theta JA}$	Junction to Ambient			40	°C/W	
V <sub>Isolation</sub>	RMS Voltage (50-60 Hz Sinusoidal Waveform From Terminals to Mounting Base for 1 Min.)	2500			Volts	
Torque	Maximum Torque for Device Mounting Screws and Electrical Terminations.			13	lb•in	

① Repetitive Rating: Pulse width limited by maximum junction temperature.

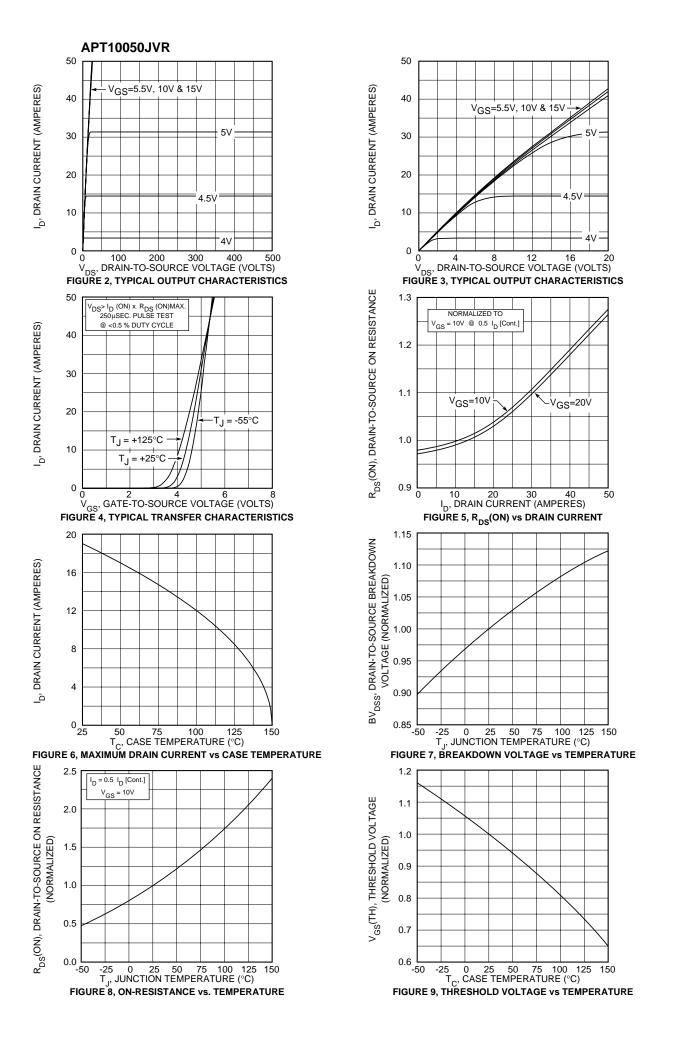
APT Reserves the right to change, without notice, the specifications and information contained herein.

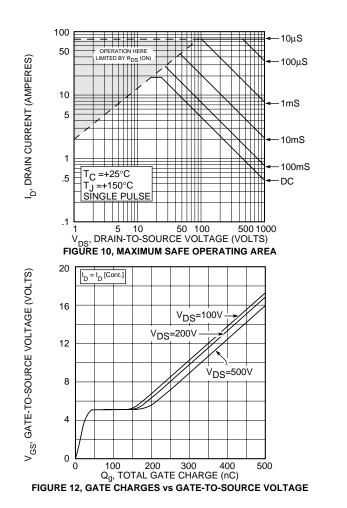


③ See MIL-STD-750 Method 3471

 $<sup>\</sup>bigcirc$  Starting T<sub>i</sub> = +25°C, L = 13.85mH, R<sub>G</sub> = 25Ω, Peak I<sub>L</sub> = 19A

 $<sup>\</sup>textcircled{2}$  Pulse Test: Pulse width < 380  $\mu$ S, Duty Cycle < 2%





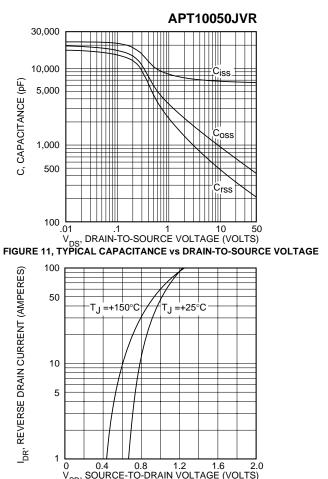
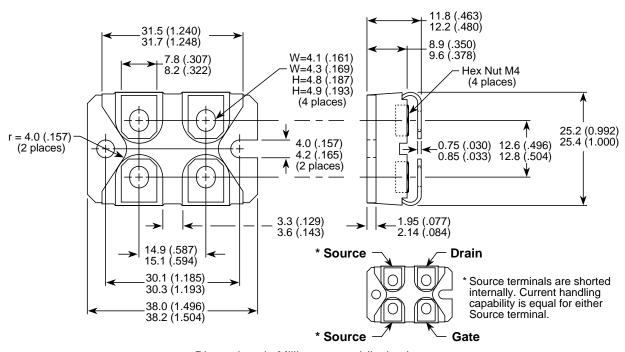


FIGURE 13, TYPICAL SOURCE-DRAIN DIODE FORWARD VOLTAGE

#### SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

"UL Recognized" File No. E145592

050-5575 Rev C